

**Preliminary**

Messrs. \_\_\_\_\_

## Shock Sensor Specification

Part No. : PSLE382E-R44

RoHS Compliant

Halogen-Free Compliant

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# KYOCERA CORPORATION

CIRCUIT COMPONENT DIVISION  
PIZ SECTION



**Preliminary****1.Scope**

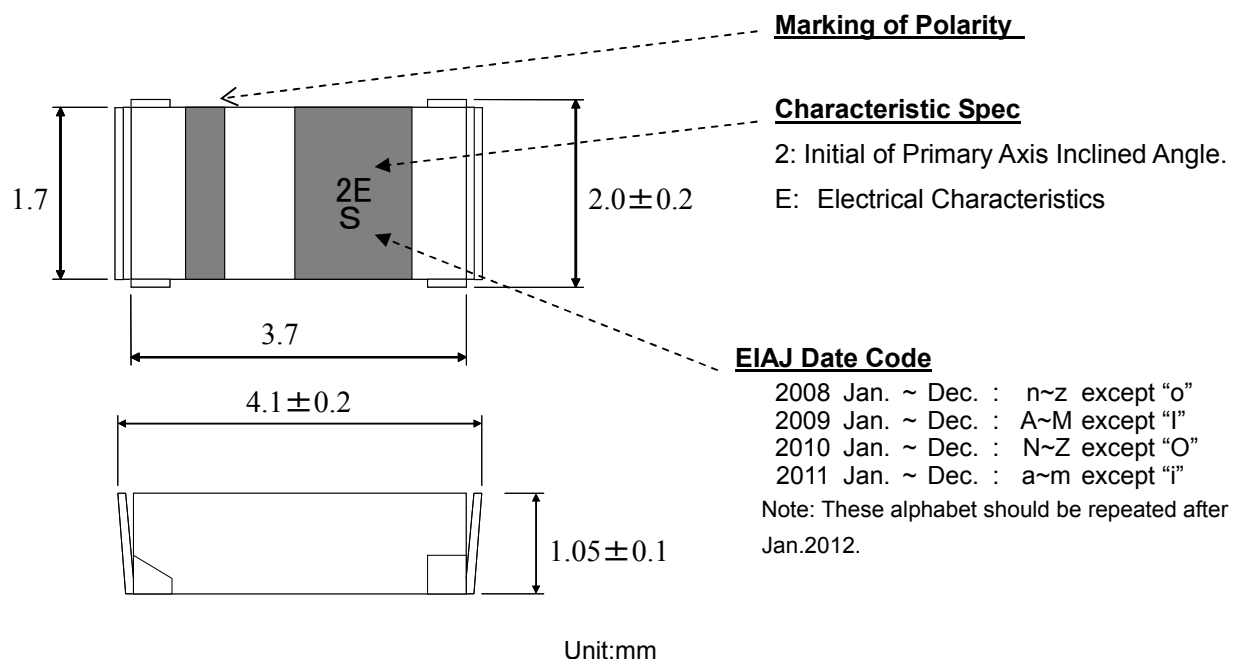
This specification shall cover the characteristics of the shock sensor.

**2.Kyocera's Type Name****PSLE382E-R44****3.Customer's Type Name****4.Electrical Characteristics**

Items	Specifications
4-1 Primary Axis Inclined Angle	25± 3degree
4-2 Capacitance	340 ± 160pF, at 1Vrms, 1kHz
4-3 Charge Sensitivity	0.09 ± 0.035 pC/G , under vibration at 200Hz, 2G
4-4 Insulation Resistance	0.5Gohm minimum, at 10VDC after 1min.
4-5 Resonant Frequency	44 ± 9kHz
4-6 Non-linearity	5% maximum, under vibration at 25G
(Referense only) Voltage Sensitivity	0.265mV/G ,under vibration at 200Hz, 2G

<Measurement Condition>

The reference temperature shall be 25 °C ±5°C.

**5.Dimensions and Marking****Fig.1**

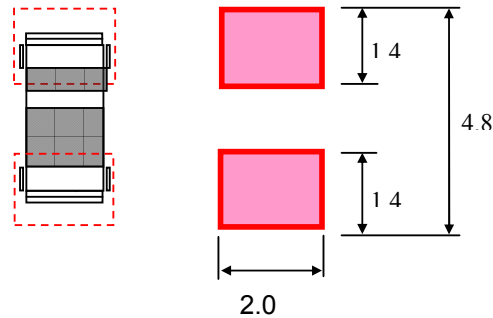
**6.Environmental Characteristics****Preliminary**

Items	Conditions
6-1.High Temperature Storage Test	Keep in a chamber at $85 \pm 2^{\circ}\text{C}$ for $1000 +12/-0$ hours, and then keep at room temperature for 1 hour. The characteristics of shock sensor shall meet the specifications.
6-2.Low Temperature Storage Test	Keep in a chamber at $-40 \pm 2^{\circ}\text{C}$ for $1000 +12/-0$ hours, and then keep at room temperature for 1 hour. The characteristics of shock sensor shall meet the specifications.
6-3.Moisture Resistance Test	Keep in a chamber at 90 to 95 % R.H. and $60 \pm 2^{\circ}\text{C}$ for $500 +12/-0$ hours, and then keep at room temperature for 1 hour. The characteristics of shock sensor shall meet the specifications.
6-4.Temperature Cycling Test	Apply 100 thermal cycles with the following temperatures: <ul style="list-style-type: none"> <li>- upper temperature <math>85^{\circ}\text{C}</math> for 20 minutes and transfer time 10 minutes</li> <li>- lower temperature <math>-40^{\circ}\text{C}</math> for 20 minutes and transfer time 10 minutes</li> <li>- total cycle time is 1hour</li> </ul> and then left at room temperature for 1 hour. The characteristics of shock sensor shall meet the specifications.
6-5.Mechanical Shock Test	After applying the acceleration at $29430\text{m}/\text{sec}^2$ {3000G} in each of X, Y and Z axis (each 3 times). The characteristics of shock sensor shall meet the specifications.
6-6.Solderability Test	At first, being soaked in the Methanol solution containing Rosin for 5 seconds and then being dipped in a bath of Pb/Sn solder at $250 \pm 5^{\circ}\text{C}$ for $4 \pm 0.5$ seconds. The surface of the electrode terminal shall be soldered more than 95%.
6-7.Resistance to Soldering Heat Test	Pre-heat temperature is 150 to $180^{\circ}\text{C}$ for 1 minute. High temperature is $250 \pm 5^{\circ}\text{C}$ , over $200^{\circ}\text{C}$ for 20 seconds max.(2times). Then keep at room temperature for 1 hour. The characteristics of shock sensor shall meet the specifications.
6-8.Board Flex Test	After soldered on the circuit board specified as below, then the load which cause 3 mm bend to the board is applied. The characteristics of shock sensor shall meet the specifications. The shock sensor cause no defect in the appearance. (Circuit Board: FR4, 100 x 40 x 1.6 ) <div style="text-align: center;"> </div>

**<Measurement Condition>**The reference temperature shall be  $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ .

## 7. Recommended Land pattern

Preliminary



Unit: (mm)

Fig.2 Recommended Land pattern

## 8. Recommended Convection Reflow profile

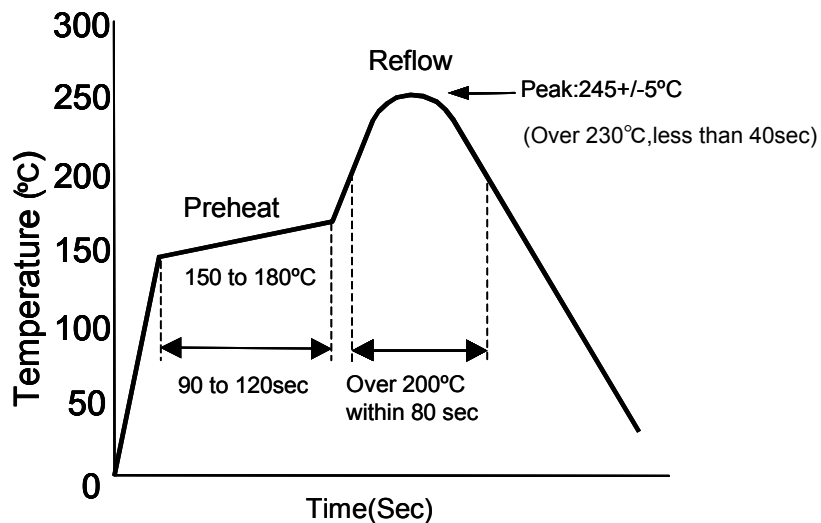
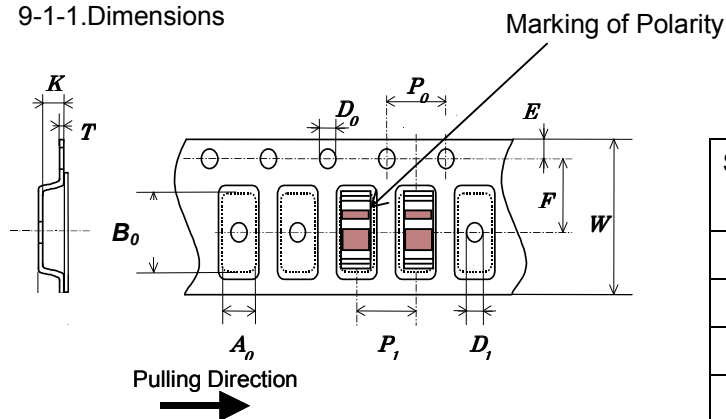


Fig.3 Recommended Convection Reflow profile

## 9. Taping Specifications

### 9-1. Carrier Tape

#### 9-1-1. Dimensions



Unit: (mm)

Sym bol	Dimensions	Sym bol	Dimensions
$A_0$	$2.25 \pm 0.1$	$P_0$	$4.0 \pm 0.1$
$B_0$	$4.4 \pm 0.1$	$P_1$	$4.0 \pm 0.1$
$W$	$12.0 +0.3/-0.1$	$D_0$	$1.5 +0.1/-0$
$E$	$1.75 \pm 0.1$	$K$	$1.25 \pm 0.1$
$F$	$5.5 \pm 0.05$	$T$	$0.3 \pm 0.05$

Fig.4 Emboss Carrier Tape Dimensions

## 9-2. Taping

**Preliminary**

## 9-2-1. Taping Quantity

One reel of the carrier tape shall pack 3000 pcs. Shock sensor shall be contained in pocket continuously.

## 9-2-2. Dimensions

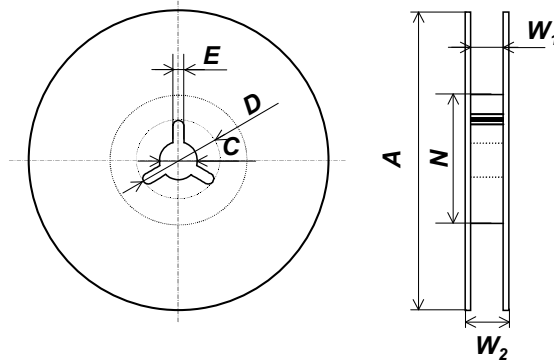


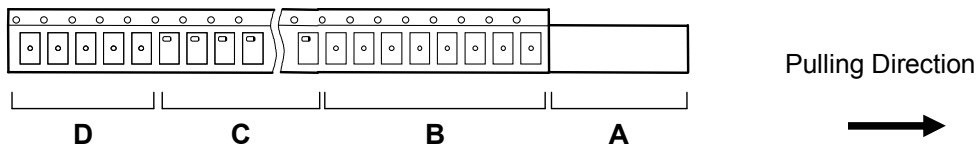
Fig.5 Reel

Unit: (mm)

Symbol	<b>A</b>	<b>N</b>	<b>W<sub>1</sub></b>	<b>W<sub>2</sub></b>
Dimensions	180±5.0	60min.	12.5 +2.0/-0.0	20.5 max.
Symbol	<b>C</b>	<b>D</b>	<b>E</b>	
Dimensions	13.0±0.2	21.0±0.8	2.0±0.5	

## 9-2-3. Leader and Blank Pocket

Package shall consist of leader, blank pocket and loaded pocket as follows. (fig.6)



- A) Leader
- B) Blank Pocket (160mm Min.)  
A+B: 400mm to 560mm
- C) Load Pocket
- D) Blank Pocket (40 to 190mm )

Fig.6 Packing Method

Peeling load of top tape shall be 0.1N {10gf} to 0.7N {70gf} from Carrier Tape.

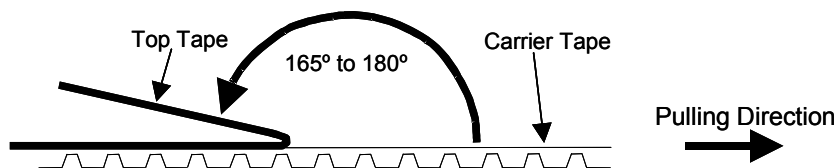


Fig.7 Peeling Strength

**9-2-4. Reel label**

A reel label shall be contained as below: (Based on EIAJ C-3 format)

- A) Customer P/N
- B) Lot No.
- C) Quantity
- D) Shipping date
- E) Vender Name

**9-2-5. Exterior Package label**

Shock sensor shall be packed properly to avoid defect in transportation and the marking of exterior package shall be contained as below:

- A) Name of Customer
- B) P/O No.
- C) Customer P/N
- D) Lot No.
- E) Quantity
- F) Shipping Date
- G) Vender Name

**10. The agreement of this specifications**

Should any part of the content of this specification become questionable, it shall be settled by mutual deliberations.

**11. Remarks on Usage**

- A) This part can use only reflow soldering.
- B) Not washable
- C) Maximum temperature is 280 degree.

**12. RoHS Compliant**

- A) Sensor Case: LCP(liquid crystal polymer)
- B) Terminal: Bronze with phosphate (thickness 100 um)  
Plating: Cu(1-2um), Ag(1-3 um)
- C) Element: Piezo Ceramic, contains lead-oxide, however, piezo-electronic devices are exempted from RoHS compliant requirement of article 4(1).  
(Refer to Annex, Section 7)

**All materials meet to RoHS Compliant.**

**13. Halogen-Free Compliant**

- A) Bromine (Br) <900ppm(0.09%)
- B) Chlorine (Cl) <900ppm(0.09%)
- C) Total concentration of Chlorine (Cl) + Bromine (Br) < 1500ppm(0.15%)
- D) Antimony Trioxide (Sb<sub>2</sub>O<sub>3</sub>) <1000ppm(0.1%)
- E) Red Phosphorus <1000ppm(0.1%)

**All materials meet to Halogen-Free Compliant.**